

**DGM181-185, DGM190-191****High Reliability High-Speed CMOS Analog Switch****GENERAL DESCRIPTION**

The DGM181 family of CMOS monolithic switches utilizes Intersil's latch-free junction isolated processing to combine the speed of the hybrid DG181 family with the reliability and low power consumption of a monolithic CMOS construction. These devices, therefore, are a cost effective replacement for the DG181 family.

The DGM181 family has a high state threshold of 2.4V, and a low state of +0.8V.

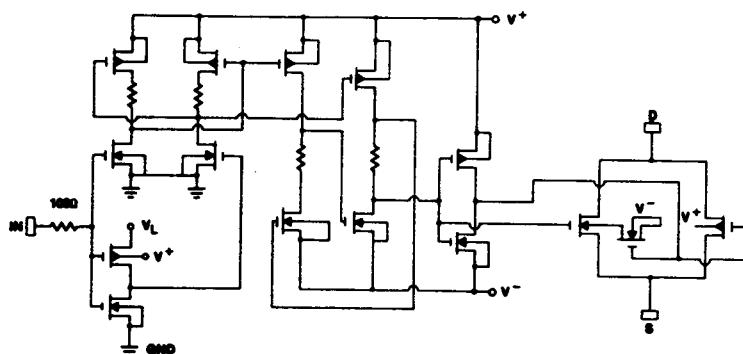
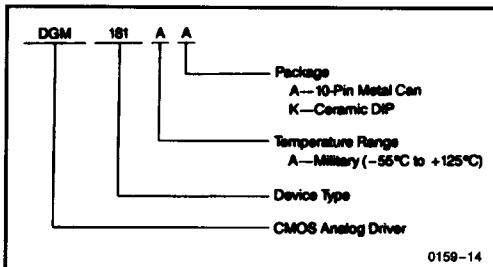
Very low quiescent power is dissipated in either the ON or OFF state of the switch. Maximum power supply current is 10 $\mu$ A from any supply, and typical quiescent currents are in the 10nA range. OFF leakages are typically less than 200pA at 25°C.

**ORDERING INFORMATION**

Type	Standard Part Number	$I_{DS(on)}$ Max at 25°C
Dual SPST	DGM181AK	50
	DGM182AK	50
Dual DPST	DGM184AK	50
	DGM185AK	50
Dual SPDT	DGM190AK	50
	DGM191AK	50

**FEATURES**

- Pin and Function Replacement for DG181 Family
- Meets or Exceeds All DG181 Family Specifications With Monolithic Reliability
- Low Power Consumption
- 1nA Leakage From Signal Channel In Both ON and OFF States
- TTL, DTL, RTL Direct Drive Capability
- $t_{on}, t_{off} < 150\text{ns}$ , Break-Before-Make Action
- Crosstalk and Open Load Switch Isolation >50dB at 10MHz (75 $\Omega$  Load)

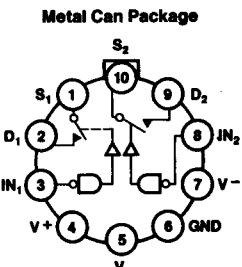


0159-1

**Figure 1: Functional Diagram (Typical Channel)**

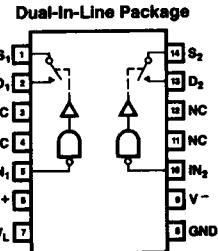
# DGM181-185 DGM190-191

2

**DUAL SPST (DGM181, 182)**

(OUTLINE DWG TO-100)

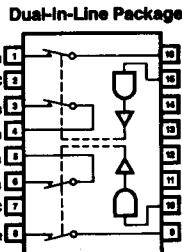
0159-2



(OUTLINE DWGS JD, PD)

0159-4

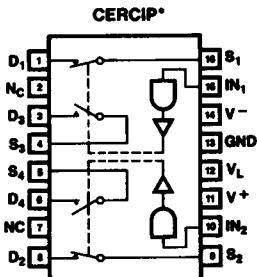
SWITCH STATES ARE FOR LOGIC "1" INPUT

**DUAL DPST (DGM184, 185)**

(OUTLINE DWGS JE, PE)

0159-6

SWITCH STATES ARE FOR LOGIC "1" INPUT

**DUAL SPDT (DGM190, 191)**

(OUTLINE DWGS JE, PE)

0159-11

SWITCH STATES ARE FOR LOGIC "1" INPUT

**Figure 2: Pin Configuration and Switching State Diagram**

# DGM181-185

# DGM190-191

## ABSOLUTE MAXIMUM RATINGS

$V^+ - V^-$	36V	$GND - V_{IN}$	20V
$V^- - V_D$	33V	Current (Any Terminal)	30mA
$V_D - V^-$	33V	Storage Temperature	-65°C to +150°C
$V_D - V_S$	28V	Operating Temperature	-55°C to +125°C
$V_L - V^-$	36V	Lead Temperature (Soldering, 10sec)	300°C
$V_L - V_{IN}$	30V	Power Dissipation*	450 (TW), 750 (FLAT), 825(DIP)mW
$V_L - V_{GND}$	20V		
$V_{IN} - V_{GND}$	20V		
$GND - V^-$	27V		

\* Device mounted with all leads welded or soldered to PC board. Derate 6mW/C (TW); 10mW/C (FLAT); 11mW/C (DIP) above 75°C.

NOTE: Stresses above those listed under "Absolute Maximum Ratings" may cause permanent damage to the device. These are stress ratings only and functional operation of the device at these or any other conditions above those indicated in the operational sections of the specifications is not implied. Exposure to absolute maximum rating conditions for extended periods may affect device reliability.

## ELECTRICAL CHARACTERISTICS ( $V^+ = +15V$ , $V^- = -15V$ , $V_L = 5V$ , unless noted)

Parameter	Device No.	Test Conditions (Note 1)	A Series			Units
			-55°C	+25°C	+125°C	
<b>SWITCH</b>						
$I_{S(off)}$	DGM181, 184, 190	$V_S = 7.5V$ , $V_D = -7.5V$ $V_{IN} = "OFF"$		$\pm 1$	100	nA
	DGM182, 185, 191	$V_S = 10V$ , $V_D = -10V$ $V_{IN} = "OFF"$		$\pm 1$	100	nA
$I_{D(off)}$	DGM181, 184, 190	$V_S = 7.5V$ , $V_D = -7.5V$ $V_{IN} = "OFF"$		$\pm 1$	100	nA
	DGM182, 185, 191	$V_S = 10V$ , $V_D = -10V$ $V_{IN} = "OFF"$		$\pm 1$	100	nA
$I_{D(on)} + I_{S(on)}$	DGM181, 184, 190	$V_D = V_S = -7.5V$ , $V_{IN} = "ON"$		$\pm 2$	$\pm 200$	nA
	DGM182, 185, 191	$V_D = V_S = -10V$ , $V_{IN} = "ON"$		$\pm 2$	$\pm 200$	nA
<b>INPUT</b>						
$I_{INL}$	ALL	$V_{IN} = 0V$		$\pm 1.0$	20	$\mu A$
$I_{INH}$	ALL	$V_{IN} = 5V$		$\pm 1.0$	20	$\mu A$
<b>DYNAMIC</b>						
$t_{on}$	DGM181, 184, 190 DGM182, 185, 191	See switching time test circuit		450		ns
$t_{off}$	ALL			250		
$C_{S(off)}$	DGM181, 182, 184, 185, 190, 191	$V_S = -5V$ , $I_D = 0$ , $f = 1MHz$		5pF typical		pF
$C_{D(off)}$		$V_D = +5V$ , $I_S = 0$ , $f = 1MHz$		6pF typical		
$C_{D(on)} + C_{S(on)}$		$V_D = V_S = 0$ , $f = 1MHz$		11pF typical		
OFF Isolation		$R_L = 75\Omega$ , $C_L = 3pF$		Typically > 50dB at 10MHz		
<b>SUPPLY</b>						
$I^+$	ALL	$V_{IN} = 5V$	10	10	100	$\mu A$
$I^-$	ALL		10	10	100	
$I_L$	ALL		10	10	100	
$I_{GND}$	ALL		10	10	100	
$I^+$	ALL	$V_{IN} = 0V$	10	10	100	
$I^-$	ALL		10	10	100	
$I_L$	ALL		10	10	100	
$I_{GND}$	ALL		10	10	100	

Note: 1. See Switching State Diagrams for  $V_{IN}$  and  $V_{IN}$  "OFF" Test Conditions.

**DGM181-185  
DGM190-191**

2

**ELECTRICAL CHARACTERISTICS** MAXIMUM RESISTANCES  $r_{DS(ON)}$ 

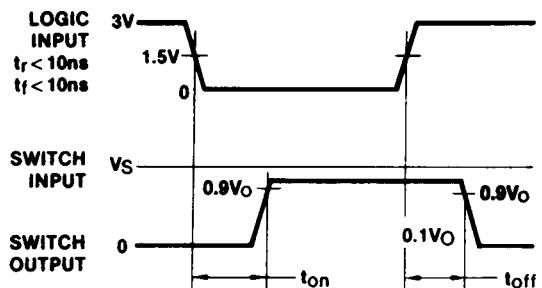
Device Number	Conditions (Note 1) $V^+ = 15V, V^- = -15V, V_L = 5V$	Military Temperature			Units
		-55°C	+25°C	+125°C	
DGM181	$V_D = -7.5V$	-	-	-	Ω
DGM182	$V_D = -10V$	50	50	75	Ω
DGM184	$V_D = -7.5V$	30	30	60	Ω
DGM185	$V_D = -10V$	50	50	75	Ω
DGM190	$V_D = -7.5V$	30	30	60	Ω
DGM191	$V_D = -10V$	50	50	75	Ω

APPLICATION COMMENT: The charge injection in these switches is of opposite polarity to that of the standard DG180 family, but considerably smaller.

**SWITCHING TIME TEST CIRCUIT**

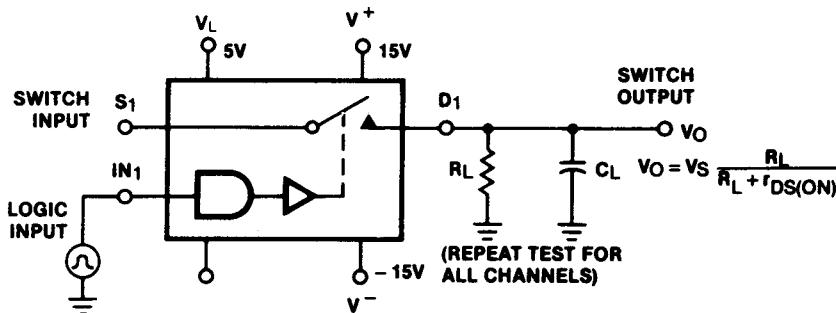
Switch output waveform shown for  $V_S = \text{constant}$  with logic input waveform as shown. Note that  $V_S$  may be + or - as per switching time test circuit.  $V_O$  is the steady state

output with switch on. Feedthrough via gate capacitance may result in spikes at leading and trailing edge of output waveform.



0159-12

Figure 3: Logic Input for "OFF" to "ON" Condition (DGM181/182 Shown)



0159-13

Figure 4: Switching Time Test Circuit

**DGM181-185****DGM190-191****SWITCH STATES****DUAL SPST DGM181/182****Test Conditions**

DGM181/182	
$V_{IN}$ "ON" = 0.8V	All Channels
$V_{IN}$ "OFF" = 2.4V	All Channels

**DUAL DPST DGM184/185****Test Conditions**

DGM184/185	
$V_{IN}$ "ON" = 2.4V	All Channels
$V_{IN}$ "OFF" = 0.8V	All Channels

**DUAL SPDT DGM190/191****Test Conditions**

DGM190/191	
$V_{IN}$ "ON" = 2.4V	Channels 1 & 2
$V_{IN}$ "ON" = 0.8V	Channels 3 & 4
$V_{IN}$ "OFF" = 2.4V	Channels 3 & 4
$V_{IN}$ "OFF" = 0.8V	Channels 1 & 2